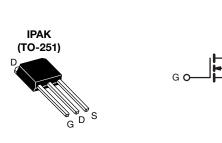
Vishay Siliconix



E Series Power MOSFET

PRODUCT SUMMARY						
V _{DS} (V) at T _J max.	700					
R _{DS(on)} max. at 25 °C (Ω)	$V_{GS} = 10 V$	0.6				
Q _g max. (nC)	48					
Q _{gs} (nC)	6					
Q _{gd} (nC)						
Configuration	Sing	le				



S N-Channel MOSFET

FEATURES

- Low figure-of-merit (FOM) Ron x Qg
- Low input capacitance (Ciss)
- Reduced switching and conduction losses
- Ultra low gate charge (Q_q)
- Avalanche energy rated (UIS)
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Industrial
 - Welding
 - Induction heating
 - Motor drives
 - Battery chargers
 - Renewable energy
 - Solar (PV inverters)

ORDERING INFORMATION	
Package	IPAK (TO-251)
Lead (Pb)-free and Halogen-free	SiHU6N65E-GE3

ABSOLUTE MAXIMUM RATINGS (T $_{\rm C}$	= 25 °C, unl	less otherwis	se noted)		
PARAMETER	SYMBOL	LIMIT	UNIT		
Drain-Source Voltage			V _{DS}	650	V
Gate-Source Voltage	V _{GS}	± 30	v		
Continuous Drain Current (T. 150 °C)	T _C = 25 °C		7		
Continuous Drain Current (T _J = 150 °C)	V _{GS} at 10 V	T _C = 25 °C T _C = 100 °C	I _D	5	А
Pulsed Drain Current ^a	I _{DM}	18			
Linear Derating Factor		0.63	W/°C		
Single Pulse Avalanche Energy ^b	E _{AS}	56	mJ		
Maximum Power Dissipation	P _D	78	W		
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to +150	°C		
Drain-Source Voltage Slope	-1) / /-14	37			
Reverse Diode dV/dt ^d	dV/dt	27	V/ns		
Soldering Recommendations (Peak Temperature) ^c	for	10 s		300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. V_{DD} = 50 V, starting T_J = 25 °C, L = 28.2 mH, R_g = 25 Ω , I_{AS} = 2 A.

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, dl/dt = 100 A/µs, starting T_J = 25 °C.

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RoHS

COMPLIANT HALOGEN

FREE



PARAMETER	SYMBOL	TYP.		MAX.		UNIT		
Maximum Junction-to-Ambient	R _{thJA}	-	- 62					
Maximum Junction-to-Case (Drain)	R _{thJC}	- 1.6			°C/W		°C/W	
SPECIFICATIONS (T _J = 25 °C, u	nless otherw	ise noted)						
PARAMETER	SYMBOL			IONS	MIN.	TYP.	MAX.	UNI
Static	••••••							
Drain-Source Breakdown Voltage	V _{DS}	Ves	= 0 V, I _D =	250 µA	650	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_J$. 5	$I_{\rm D} = 1 {\rm mA}$	-	0.73	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	-	= V _{GS} , I _D =		2	_	4	V
	• GS(III)		$V_{GS} = \pm 20$		-	_	± 100	nA
Gate-Source Leakage	I _{GSS}		$V_{GS} = \pm 30$		-	_	± 100	μA
					_	_	1	μ, ι
Zero Gate Voltage Drain Current	I _{DSS}		$V_{DS} = 650 \text{ V}, V_{GS} = 0 \text{ V}$ $V_{DS} = 520 \text{ V}, V_{GS} = 0 \text{ V}, T_J = 125 \text{ °C}$		_	_	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V I _D = 3 A		-	0.5	0.6	Ω	
Forward Transconductance	g fs	V _{DS}	= 30 V, I _D) = 3 A	-	2	-	S
Dynamic								
Input Capacitance	C _{iss}	$V_{GS} = 0 V, \\ V_{DS} = 100 V, \\ f = 1 MHz$		-	820	-	pF	
Output Capacitance	Coss			-	40	-		
Reverse Transfer Capacitance	C _{rss}			-	4	-		
Effective Output Capacitance, Energy Related ^a	C _{o(er)}	- V _{DS} = 0 V to 520 V, V _{GS} = 0 V		-	36	-		
Effective Output Capacitance, Time Related ^b	C _{o(tr)}			-	117	-		
Total Gate Charge	Qg				-	24	48	nC
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	I _D = 3	A, V _{DS} = 520 V	-	6	-	
Gate-Drain Charge	Q _{gd}				-	11	-	
Turn-On Delay Time	t _{d(on)}				-	14	28	
Rise Time	t _r	Vpp	V _{DD} = 520 V, I _D = 3 A,		-	12	24	
Turn-Off Delay Time	t _{d(off)}	$V_{\rm GS} = 10 \text{ V}, \text{ R}_{\rm g} = 9.1 \Omega$		-	30	60	ns	
Fall Time	t _f			-	20	40		
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	1.4	-	Ω	
Drain-Source Body Diode Characteristic	S							
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the		-	-	7		
Pulsed Diode Forward Current	I _{SM}	integral revers p - n junction			-	-	18	A
Diode Forward Voltage	V _{SD}	T _{.J} = 25 °	C, I _S = 3 A	A, V _{GS} = 0 V	_	-	1.3	V
Reverse Recovery Time	t _{rr}	<u> </u>			-	237	-	ns
Reverse Recovery Charge	Q _{rr}	$T_{\rm J} = 2$	$^{\circ}$ C, I _F =	I _S = 3 A, V _B = 25 V	-	2.2	-	μC
Reverse Recovery Current	I _{RRM}	ai/at =	του Avµs,	v _R = ∠ɔ v	-	16		A

Notes

a. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . b. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

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Vishay Siliconix

TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

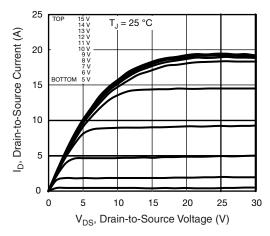


Fig. 1 - Typical Output Characteristics

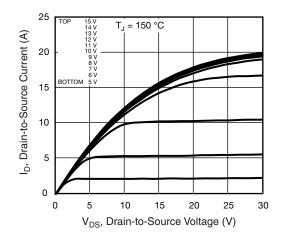


Fig. 2 - Typical Output Characteristics

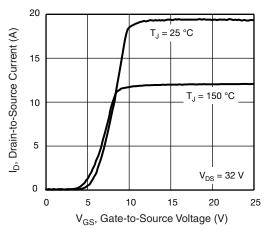


Fig. 3 - Typical Transfer Characteristics

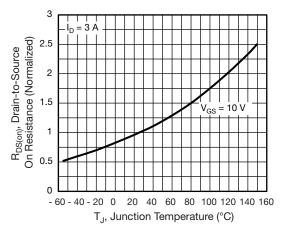


Fig. 4 - Normalized On-Resistance vs. Temperature

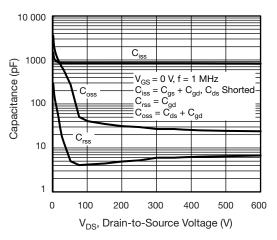


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

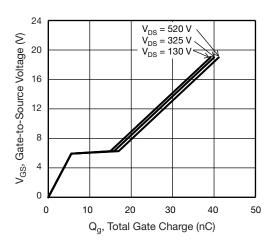


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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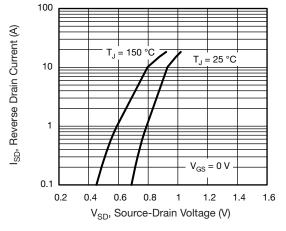


Fig. 7 - Typical Source-Drain Diode Forward Voltage

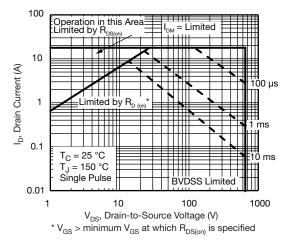


Fig. 8 - Maximum Safe Operating Area

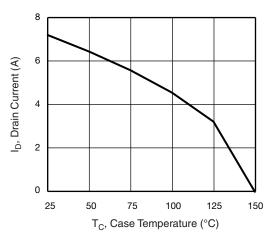


Fig. 9 - Maximum Drain Current vs. Case Temperature

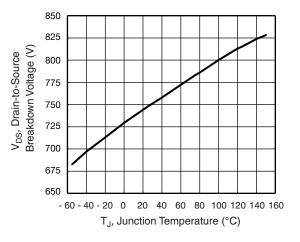
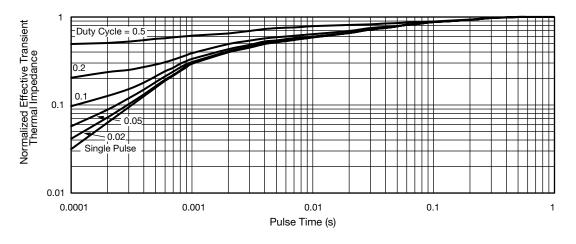
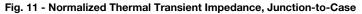


Fig. 10 - Temperature vs. Drain-to-Source Voltage





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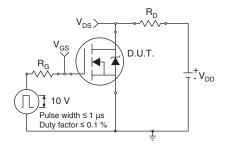


Fig. 12 - Switching Time Test Circuit

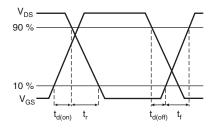


Fig. 13 - Switching Time Waveforms

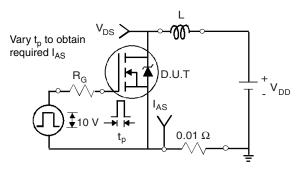


Fig. 14 - Unclamped Inductive Test Circuit

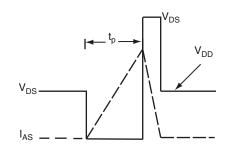


Fig. 15 - Unclamped Inductive Waveforms

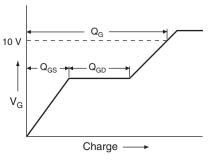


Fig. 16 - Basic Gate Charge Waveform

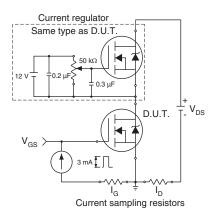
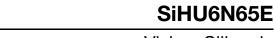


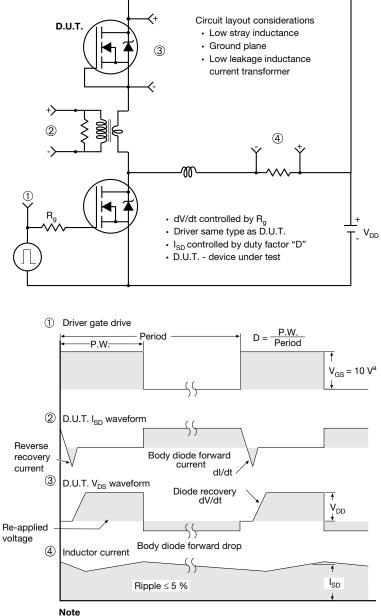
Fig. 17 - Gate Charge Test Circuit

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Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5$ V for logic level devices

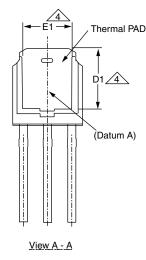
Fig. 18 - For N-Channel

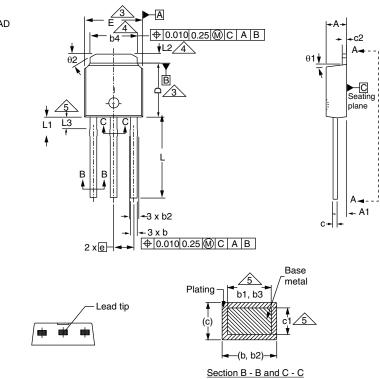
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Case Outline for TO-251AA (High Voltage)

OPTION 1:





	MILLIMETERS		INCHES			MILLIMETERS		INCHES	
DIM.	MIN.	MAX.	MIN.	MAX.	DIM.	MIN.	MAX.	MIN.	MA
А	2.18	2.39	0.086	0.094	D1	5.21	-	0.205	-
A1	0.89	1.14	0.035	0.045	E	6.35	6.73	0.250	0.2
b	0.64	0.89	0.025	0.035	E1	4.32	-	0.170	-
b1	0.65	0.79	0.026	0.031	е	2.29	BSC	2.29	BSC
b2	0.76	1.14	0.030	0.045	L	8.89	9.65	0.350	0.3
b3	0.76	1.04	0.030	0.041	L1	1.91	2.29	0.075	0.0
b4	4.95	5.46	0.195	0.215	L2	0.89	1.27	0.035	0.0
С	0.46	0.61	0.018	0.024	L3	1.14	1.52	0.045	0.0
c1	0.41	0.56	0.016	0.022	θ1	0'	15'	0'	15
c2	0.46	0.86	0.018	0.034	θ2	25'	35'	25'	35
D	5.97	6.22	0.235	0.245		•	•	•	•

Notes

- Dimensioning and tolerancing per ASME Y14.5M-1994
- Dimension are shown in inches and millimeters
- Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- Thermal pad contour optional with dimensions b4, L2, E1 and D1
- Lead dimension uncontrolled in L3
- Dimension b1, b3 and c1 apply to base metal only
- Outline conforms to JEDEC® outline TO-251AA

Revision: 25-Oct-2021

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Document Number: 91362

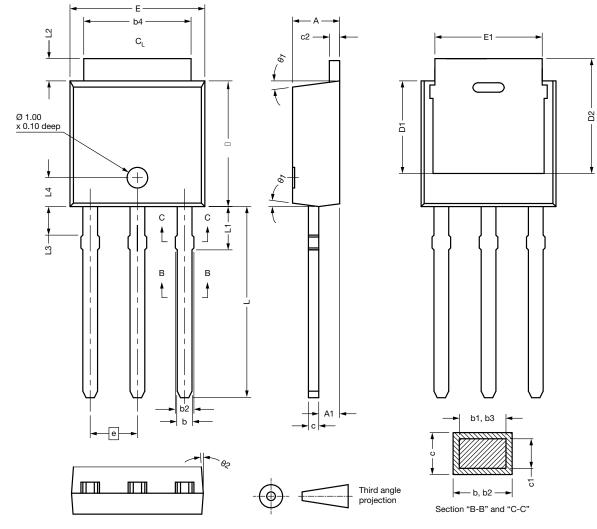
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OPTION 2: FACILITY CODE = N

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DIM.	MIN.	MAX.	MAX.	DIM.	MIN.	MAX.	MAX.
А	2.180	2.285	2.390	D2	5.380	-	-
A1	0.890	1.015	1.140	E	6.350	6.540	6.730
b	0.640	0.765	0.890	E1	4.32	-	-
b1	0.640	0.715	0.790	е	2.29	BSC	
b2	0.760	0.950	1.140	L	8.890	9.270	9.650
b3	0.760	0.900	1.040	L1	1.910	2.100	2.290
b4	4.950	5.205	5.460	L2	0.890	1.080	1.270
С	0.460	-	0.610	L3	1.140	1.330	1.520
c1	0.410	-	0.560	L4	1.300	1.400	1.500
c2	0.460	-	0.610	θ1	0°	7.5°	15°
D	5.970	6.095	6.220	θ2	4°	-	-
D1	4.300	-	-		•	•	

Notes

• Dimensioning and tolerancing per ASME Y14.5M-1994

• All dimension are in millimeters, angles are in degrees

• Heat sink side flash is max. 0.8 mm

Revision: 25-Oct-2021



RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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